LAMB WAVE MICROMECHANICAL RESONATORS FORMED IN THIN PLATES OF LITHIUM NIOBATE

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ABSTRACT

We study and compare high coupling symmetric and shear mode Lamb wave resonators realized in thin plates of X-cut lithium niobate. Fundamental mode bar resonators with a plate width of 20 μm , a plate thickness of 1.5 μm , apertures of 50, 90 and 130 μm and acoustic wave propagation rotated 30° (symmetric) and 170° (shear) to the +y-axis were realized on a single die for direct comparison. As expected, the symmetric Lamb wave resonators exhibited a higher sound velocity of ~6400 m/s when compared to the shear velocity of ~3900 m/s. The shear mode resonators, however, were found to have a significantly higher effective piezoelectric coupling coefficient of 16.3%, compared to a maximum of 9.1% for the symmetric Lamb wave resonators. In addition, the shear mode resonators were found to be less sensitive to the device aperture and to have fewer spurious responses. Based on these results, the shear mode resonators were selected for scaling to higher operating frequencies. A shear mode lithium niobate Lamb wave resonator operating at 350 MHz has been demonstrated with an effective piezoelectric coupling of 16%, a quality factor in air of 2200 and a device figure-of-merit of 420, among the highest reported for Lamb wave resonators [1-3].

INTRODUCTION

Microresonator filter arrays have been studied as a smaller, more highly integrated replacement for the numerous filters dies that currently reside in the RF front-end of a multi-band cellular handset. In particular, microresonators realized in thin films of lithium niobate (LiNbO_3) [1-3] have demonstrated the high piezoelectric coupling needed to realize band select filters with percent bandwidths of 2-5%, while simultaneously exhibiting the high quality factors required for duplexers with narrow frequency gaps between the transmit and receive bands.

In this paper we study and compare the properties of Lamb wave resonators vibrating in the fundamental symmetric (S0) and shear (SH0) modes. These modes were chosen because they are predicted [4] to have both low dispersion and high coupling coefficient over a wide range of thickness-to-wavelength ratios (h/λ). Both of these properties are important for realizing multi-frequency band select filters in a single LiNbO_3 layer.

Fundamental mode resonators with a plate width of 20 μm , a plate thickness of 1.5 μm , varying apertures and acoustic wave propagation rotated 30° (S0) and 170° (SH0) to the +y-axis to maximize piezoelectric coupling [4] were realized on a single die for direct comparison. The h/λ of 0.04 is very close to the optimum value to maximize piezoelectric coupling of 0.05 found for both the S0 and SH0 modes in [4]. We find that while the S0 Lamb wave has a 1.6 times higher sound velocity than the SH0 mode, the SH0 mode is predicted to and consistently exhibits a 1.6-1.8 times higher effective piezoelectric coupling coefficient, k_{eff}^2 . The SH0 mode also exhibits higher quality factor (Q), higher figure-of-merit (M) and fewer spurious responses.

Finally, a fundamental SH0 mode Lamb wave resonator realized in a 4.4 μm wide plate is demonstrated with an operating frequency of 350 MHz, a $k_{\text{eff}}^2 = 16\%$, a $Q = 2200$ in air and a $M = 420$, among the highest reported for Lamb wave resonators.

DEVICE FABRICATION

The resonators are fabricated using the process flow shown in Fig. 1 [3], where selective ion irradiation of a LiNbO_3 wafer creates a damaged release layer that selectively etches in a HF chemistry, allowing suspended membranes to be formed. The advantages of this fabrication process when compared to prior art [1,2] are: 1) the ability to lithographically define the undercut of the device, 2) no wafer bonding, polishing or fracturing and 3) the ability to realize custom and potentially multiple LiNbO_3 thicknesses on a single substrate.

The process begins with an X-cut LiNbO_3 wafer upon which a 100 nm layer of Cr is deposited and patterned to form alignment marks. Next, a SiO_2 layer is deposited and patterned to determine where the release layer will be formed via ion irradiation. The sample is then implanted with a He dose of 1×10^{16} atoms/ cm^3 at an energy of 0.9 MeV to create an ion damaged release layer of LiNbO_3 approximately 2 μm below the wafer surface. This energy was found to give a final plate thickness after release of approximately 1.5 μm . The implants are performed in a 3 MV NEC Pelletron using a current of $< 7 \mu\text{A}$. A low sample temperature is maintained via liquid nitrogen cooling using a Cu braid during implantation. The ion implant is intentionally performed through the Cr electrode layer to promote adhesion. After ion implantation, the SiO_2 implant masking layer is stripped and the LiNbO_3 is patterned using an oxide hard mask and Cl dry etching to define the final plate dimensions. Next, the Cr electrodes are patterned and a layer of Au is deposited and patterned via lift off to protect the -z face of the LiNbO_3 device, which can have a significant etch rate in HF during the release. During our research we found that the structural rigidity of this Au protection layer also led to significantly improved device yield through the release process. Finally the devices are released in a HF based chemistry and the Au protect layer is stripped in KI-I₂.

Figure 1: LiNbO_3 microresonator fabrication process.

DEVICE STRUCTURE AND DIMENSIONS

A final cross-section schematic of the resonator is shown in the bottom of Fig. 1 and a scanning electron microscope (SEM) image of one of the resonators studied in this work is shown in Fig. 2. The resonator consists of a 1.5 μm thick suspended membrane of LiNbO_3 with a width, $W = 20 \mu\text{m}$. The device was designed to resonate in the fundamental S0 or SH0 mode, see Fig. 3, with a resonant frequency, $f_s = c/2W$, where c is the sound velocity of the Lamb wave. The thickness-to-wavelength ratio, $t/\lambda = 0.04$, is closer to the optimum value to maximize k_{eff}^2 of 0.05 [4] than previous work [3]. The space between the electrodes and device substrate anchor, s , was 45 μm for all devices. While it was found in [2,3] that to maximize k_{eff}^2 the electrodes should be placed at the edges of the resonator, 5 μm wide electrodes with a gap, $g = 5 \mu\text{m}$, were designed slightly offset from the resonator edge for ease of fabrication. Electrode apertures, a , which define the resonator static capacitance, of 50, 90 and 130 μm were modeled, fabricated and characterized.

Figure 2: LiNbO_3 microresonator SEM image.

Figure 3: Displacement (Full) and strain (Half) profiles of the S0 and SH0 resonator modes with an aperture of 50 μm .

FINITE ELEMENT MODELING RESULTS

The six devices with three different apertures and two different rotations to the +y-axis described above were studied using finite element modeling (FEM) and experimentally. The FEM was a full 3D representation of the device including the anchors and electrodes. Figure 3 shows the displacement and strain profiles from ANSYS FEM for the S0 Lamb wave resonator rotated 30° to the +y-axis and for the SH0 Lamb wave resonator rotated 170° (SH0) to the +y-axis, both with apertures of 50 μm . The maximum strain is seen to appear between the Cr electrodes and is thus efficiently transduced by the electric field applied across these same electrodes. The strain between the electrodes at

the edges of the aperture for the S0 Lamb wave resonator is seen to dramatically decrease, indicating that the S0 Lamb wave k_{eff}^2 will be significantly impacted by the device aperture. The k_{eff}^2 for each device was studied using harmonic analysis in ANSYS. The piezoelectric coupling, K^2 , was calculated from the simulated resonator admittance using eq. 1,

$$K^2 = \frac{1}{2\pi f_s Q R_X C_s}, \quad (1)$$

where f_s is the frequency of minimum resonator admittance, R_X is the resonator motional impedance, C_s is the resonator static capacitance and Q is the resonator quality factor which is an input to the FEM. The effective piezoelectric coupling was then calculated using eq. 2,

$$k_{\text{eff}}^2 = \frac{K^2}{1+K^2}. \quad (2)$$

In our previous work [3] k_{eff}^2 was calculated from the simulated resonator admittance using eq. 3,

$$k_{\text{eff}}^2 = \frac{f_p^2 - f_s^2}{f_p^2}, \quad (3)$$

where f_p is the frequency of maximum resonator admittance. The results of equations 2 and 3 are equal when no spurious resonances are seen near f_s or f_p . In this work, however, we find in both FEM and in experiments that spurious modes cause a significant increase in f_p and overestimation of k_{eff}^2 if equation 3 is used. We note here that the piezoelectric coupling coefficient, k_t^2 , reported in [1] is equal to,

$$k_t^2 = \frac{\pi^2}{8} \frac{C_X}{C_S} = \frac{\pi^2}{8} K^2 = \frac{\pi^2}{8} \frac{k_{\text{eff}}^2}{1 - k_{\text{eff}}^2}. \quad (4)$$

The simulated k_{eff}^2 vs. aperture is shown in Fig. 4 and summarized in Table 1 for both the S0 and SH0 Lamb wave resonators. The S0 Lamb wave resonator is predicted to have a significantly lower k_{eff}^2 that is much more sensitive to the aperture than the SH0 Lamb wave resonator.

Figure 4: FEM and experimental k_{eff}^2 vs. aperture.

EXPERIMENTAL RESULTS

The admittance of the six different resonators realized on the same die was measured in air using a network analyzer. The responses for the S0 and SH0 mode resonators with an aperture of 90 μm are shown in Fig. 5 (S0) and in Fig. 6 (SH0). Also shown in Fig. 5 and Fig. 6 are the results of the FEM for each device simulated with the measured quality factors. Each resonator measurement was fit to the modified Butterworth Van Dyke (MBVD) equivalent circuit model shown in Fig. 7 using eq. 5-7,

Table 1. Experimental and FEM results for the S0 and SH0 Lamb wave micromechanical resonators.

Mode	Orientation to +Y axis	Aperture (μm)	Freq. (MHz)	R_S (Ω)	R_X (Ω)	C_S (fF)	FEM Model k_{eff}^2 (%)	Measured k_{eff}^2 [2,3] (%)	Measured k_t^2 [1] (%)	Q_{Total}	Q_A	FOM $k_{eff}^2 Q_A / (1 - k_{eff}^2)$
S0	30°	50	158.9	194	3516	9	12.4	5.6	7.4	500	528	31
S0	30°	90	160.6	233	1386	12	16.2	7.8	10.5	600	701	59
S0	30°	130	161.5	272	944	18	15.0	9.1	12.3	450	580	58
SH0	170°	50	98.4	194	922	8.5	24.0	13.4	19.1	1100	1331	206
SH0	170°	90	96.9	233	702	12	25.5	16.3	24.1	750	999	195
SH0	170°	130	94.8	272	783	17	25.8	16.3	24.1	480	647	126

$$R_X = \frac{1}{2\pi f_s C_S K^2 Q_A}, \quad (5)$$

$$C_X = \frac{C_S}{K^2}, \quad (6)$$

$$L_X = \frac{R_X Q_A}{2\pi f_s} = \frac{(R_X + R_S) Q_{Total}}{2\pi f_s}, \quad (7)$$

where C_X and L_X are the motional capacitance and inductance, R_S is the series electrical resistance, Q_A is the acoustic quality factor and Q_{Total} is the measured 3 dB bandwidth of the acoustic admittance divided by f_s , which includes the losses from both R_X and R_S . R_S was measured directly on a separate test structure allowing it to be extracted from R_X . The simulated response of the MBVD electrical equivalent circuit model for the S0 and SH0 mode micromechanical resonators with an aperture of 90 μm are shown in Fig. 5 and Fig. 6 along with the equivalent circuit parameters.

Figure 5: FEM and experimental results for the S0 Lamb wave resonator with an aperture of 90 μm.

Figure 6: FEM and experimental results for the SH0 Lamb wave resonator with an aperture of 90 μm.

Figure 7: Modified BVD resonator equivalent circuit model.

The simulated MBVD results and experimental measurements are in good agreement far from resonance and close to the series resonance. The experimental k_{eff}^2 for each resonator was calculated from the MBVD equivalent circuit model using either equation 2 or 3 which yield identical results since no spurious responses are modeled using the circuit in Fig. 7. From Fig. 5 it is apparent that using the measured frequency of maximum admittance in equation 3 dramatically overestimates the k_{eff}^2 due to the spurious modes between f_s and f_p . The measured f_s , R_S , R_X , C_S , k_{eff}^2 , k_t^2 , Q_{Total} , Q_A and acoustic figure-of-merit are summarized for all the resonators in Table 1, while the measured k_{eff}^2 vs. aperture is shown in Fig. 4. The SH0 resonators are found to have significantly higher effective piezoelectric coupling coefficient and figure-of-merit.

SCALING TO HIGHER FREQUENCIES

From Table 1, the resistance of the Cr electrodes is seen to significantly degrade the total resonator quality factor. Higher frequency operation can only result in further degradation in Q_{Total} as the electrode cross sectional area will decrease, causing R_S to increase and R_X to decrease (see eq. 5). For this reason, when scaling to higher operating frequencies, the Cr electrodes in Fig. 1 were replaced with 100 nm of Au (lower resistivity compared to Cr) and the Au -z face protection mask step was omitted from the fabrication process.

The measured admittance of a SH0 Lamb wave resonator rotated 170° to the +y-axis with a plate width, $W = 4.4$ μm, an aperture, $a = 60$ μm, an electrode width of 1 μm and a gap between the electrodes, $g = 2$ μm, is shown in Fig. 8 and Fig. 9. Also shown in both figures is the simulated response of the MBVD equivalent circuit. The narrowing of the plate width to 4.4 μm has increased the series resonant frequency to 350 MHz. The inclusion of the Au electrodes has reduced the series electrical resistance to the point where it need not be modeled, $R_S = 0$ Ω and $Q_A = Q_{Total}$. The increase in the effective electrode aperture to nearly 7 wavelengths has enabled a corresponding increase in the device quality factor to 2200. The ultra-high frequency (UHF) band resonator maintains a high effective coupling coefficient, $k_{eff}^2 = 16\%$ and a device figure-of-merit, $M = 420$. The performance of the UHF, fundamental SH0 mode LiNbO₃ micromechanical resonator is summarized in Table 2.

Table 2. Experimental results for a SH0 Lamb wave resonator operating in the ultra-high frequency (UHF) band.

Mode	Orientation to +Y axis	Plate Width (μm)	Aperture (μm)	Freq. (MHz)	R_x (Ω)	C_s (fF)	Measured k_{eff}^2 [2,3] (%)	Measured k_t^2 [1] (%)	Q	FOM $k_{\text{eff}}^2 Q / (1 - k_{\text{eff}}^2)$
SH0	170°	4.4	64	350	68	16	16	23.6	2200	420

Figure 8: Experimental (black) and equivalent circuit model (red) admittance for a SH0 Lamb wave resonator with a plate width of 4.4 μm .

Figure 9: Experimental (black) and equivalent circuit model (red) admittance for a SH0 Lamb wave resonator with a plate width of 4.4 μm .

CONCLUSIONS

We have studied, theoretically and experimentally, fundamental mode S0 and SH0 Lamb wave resonators realized in thin plates of LiNbO₃. The devices are fabricated using a newly developed process that allows the formation of a damaged LiNbO₃

sacrificial layer using Helium ion implantation. This damaged LiNbO₃ is subsequently etched in a HF acid based wet release. The plate width, which determines the resonant frequency, is 20 μm wide for both the S0 and SH0 mode resonators and the thickness-to-wavelength ratio for both types of resonators is 0.04, near the optimum value to maximize piezoelectric coupling found in [4]. The acoustic wave propagation is rotated 30° (S0) and 170° (SH0) to the +y-axis for the resonators, also an optimum condition to maximize piezoelectric coupling reported in [4]. We find that the SH0 mode microresonators consistently exhibit higher effective piezoelectric coupling, quality factor and figure-of-merit when compared to identically designed S0 mode structures. The properties of the SH0 mode resonators are less sensitive to the device aperture and the SH0 mode resonators exhibit fewer spurious responses. While the initial study was performed on LiNbO₃ microresonators operating at 97 (SH0) and 160 (S0) MHz, a SH0 mode microresonator in a 4.4 μm wide LiNbO₃ plate has been demonstrated at 350 MHz. The $k_{\text{eff}}^2 = 16\%$, $Q = 2200$ and $M = 420$ for the 350 MHz microresonator are among the highest demonstrated for this new class of resonant micro-devices.

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REFERENCES

- [1] S. Gong and G. Piazza, "Design and analysis of lithium-niobate-based high electromechanical coupling RF-MEMS resonators for wideband filtering", IEEE Trans. on Microwave Theory and Tech., 61, 1 (2013).
- [2] R.R. Wang, S.A. Bhawe, and K. Bhattacharjee, "Thin-film high $k_t^2 Q$, multi-frequency lithium niobate resonators", Technical Digest of the IEEE International Conference on Micro Electro Mechanical Systems, (2013), pp. 165-168.
- [3] R.H. Olsson III et al., "A high electromechanical coupling coefficient SH0 Lamb wave lithium niobate micromechanical resonator and a method for fabrication", Sensors and Actuators A 209 (2014) 183–190.
- [4] I.E. Kuznetsova et al., "Investigation of acoustic waves in thin plates of lithium niobate and lithium tantalite", IEEE Trans. on Ultrasonics, Ferroelectrics and Frequency Cntrl., 48, 1 (2001).

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